

Si2 DAC Events/2025

Advancing Semiconductor Design

Presented by the Silicon Integration Initiative

June 22 and June 24 | Moscone West | San Francisco

***Tutorial -- Powering the Future: Mastering
IEEE 2416 System-Level Power Modeling Standard
for Low-Power AI and Beyond***

Sunday, June 22, 9:00 - 12:30 PM | Moscone West, Room 3008
Register at www.dac.com

***IEEE 2416 System Power Modeling
Working Group Open Meeting***

Tuesday, June 24, 10:00 - 11:30 AM | Moscone West, Room 3016
REGISTRATION REQUIRED

***Panel -- Powering the Future of AI:
Are Standards an Enabler or a Bottleneck?***

Free Lunch for the First 50 Attendees
Tuesday, June 24, 12:00 - 1:00 PM | Moscone West, Room 3016
REGISTRATION REQUIRED

Si2 OpenAccess Coalition Forum

Free Lunch for the First 50 Attendees
Tuesday, June 24, 1:00 - 2:45 PM | Moscone West, Room 3016
REGISTRATION REQUIRED

***Si2 Annual Member Meeting and Power
of Partnerships Award Celebration***

With a Presentation from NVIDIA
Followed by a Reception
Tuesday, June 24, 4:00 - 6:00 PM | Moscone West, Room 3016
For Si2 Members and Their Guests
REGISTRATION REQUIRED

All meeting attendees must be registered for at least the “I Love DAC” level, which is available free [here](#) until June 9.



Powering the Future

Mastering IEEE 2416 System-Level Power Modeling Standard for Low-Power AI and Beyond

Sunday, June 22, 2025, 9:00 AM - 12:30 PM

Moscone West , Room 3008

Register at www.dac.com

This tutorial will provide attendees with a comprehensive understanding of the IEEE 2416 standard, used for system-level power modeling in the design and analysis of integrated circuits and systems. Participants will gain practical knowledge necessary to implement and utilize the standard effectively. The tutorial will highlight the pressing need for low-power design methodologies, particularly in cutting-edge fields like AI, where computational demands are high. By getting a clear understanding of the IEEE 2416 standard, attendees will be equipped to make decisions on how the standard can be incorporated into their design flow to deliver the efficiencies needed to build their cutting edge low power designs. The presenters, who are experts from different industry segments (EDA, Foundry, SoC and IP) and academia who will use the IEEE 2416 standard positioned for a 2025 release.

Agenda

- Introduction to IEEE 2416 and Power Modeling Evolution
- Core Concepts of IEEE 2416 – Digital and AMS Highlights
- Real-World Applications – Industry Deep Dives
- System-Level Example: AI Accelerator with AMS Blocks

Who Should Attend

- IP Developers: Engineers responsible for designing and characterizing IP blocks who need to create accurate and efficient power models.
- SoC Architects and Designers: Professionals involved in system-level design and integration who require a deep understanding of power analysis and optimization using the 2416 standard.
- EDA Tool Providers and Users: Developers and users of EDA tools who integrate and leverage the capabilities of the 2416 standard in their workflows.

Organizers

- Nagu Dhaswada, IBM
- Leigh Anne Clevenger, Si2

Authors

- Daniel Cross, Cadence Design Systems
- Rhett Davis, NCSU
- Eunju Hwang, Samsung
- Tavares Forby, Qualcomm
- Akil Sutton, IBM



IEEE 2416 System Power Modeling Working Group Open Meeting

Tuesday, June 24, 2025, 10:00 - 11:30 AM

Moscone West , Room 3016

Complimentary Registration

In the current dynamically changing landscape of computing, the growth of artificial intelligence (AI) applications has caused an exponential increase in energy consumption, re-emphasizing the need for managing power footprint in chip design.

To manage this escalating energy footprint and enable true system-level low-power design, modeling standards play a key role in facilitating interoperability and re-use. The IEEE 2416 system-level power modeling standard, introduced in 2019, offers a unified framework spanning system-level to detailed design, facilitating comprehensive low-power design for entire systems. This standard enables efficiency through contributor-based process, voltage, and temperature (PVT) independent power modeling.

The IEEE 2416 standard is currently positioned for a 2025 release with production industry-driven extensions in analog/mixed-signal, system modeling, and multi-voltage scenarios. Join this open meeting of the IEEE 2416 committee to learn how this new release will enhance system power modeling productivity for you and your company.

Discussions Include

- New features in IEEE 2416-2025
- Ballot pool feedback and associated actions
- Standardization schedule

Organizer

Nagu Dhanwada, Chair of IEEE 2416, IBM

Advanced Registration is Required.

Click [Here](#) to Register

Powering the Future of AI: Are Standards an Enabler or a Bottleneck?

Free Lunch for the First 50 Attendees

Tuesday, June 24, 12:00 - 1:00 PM

Moscone West, Room 3016

Complimentary Registration

As AI workloads scale dramatically, power, thermal management, and reliability have emerged as critical concerns. Industry standards such as IEEE 2416 and IEEE 1801 have attempted to address these issues through system-level power and thermal modeling. But are these standards accelerating innovation, or have they become a bottleneck for rapid technological advancement?

Powering the Future of AI features panelists from industry leaders in design and methodology for power and thermal optimization, including IBM and Cadence Design Systems. The lunch forum includes experienced leaders in the semiconductor industry and EDA standardization and targets system designers and architects, logic and circuit designers, validation engineers, CAD managers, researchers, and academicians.

Key Discussion Points

- Standards: Foundation or Constraint to Innovation in AI and system-level power management?
- Practical impacts and industry adoption: Real-world experiences from semiconductor foundries, AI hardware developers, and system integrators.
- Bridging Gaps: The role of emerging IEEE 2416 extensions (A/MS, thermal, multi-voltage) in addressing AI workloads.
- Cross-industry perspectives from EDA tool vendors, system integrators, and IP developers.
- How should standards evolve to effectively enable next-generation AI applications?

Panelists

- Nagu Dhanwada, IBM, Moderator
- Sri Chilukuri, Arm
- Amit Srivastava, Synopsys
- Karan Sahni, Cadence Design Systems
- Rhett Davis, NCSU

Advanced Registration is Required.
Click [Here](#) to Register



Si2 OpenAccess Coalition Forum

Free Lunch for the First 50 Attendees

Tuesday, June 24, 1:00 - 2:45 PM

Moscone West, Room 3016

Complimentary Registration

The OpenAccess Coalition Forum features innovations from industry experts, with topics ranging from ranging from curvilinear and 3D design to multi-threading performance improvements enabled by the OpenAccess API. Presenters from coalition member companies representing successful start-ups, international design companies, and academia, will discuss the strengths of OpenAccess technology and the value of membership.

Who Should Attend

- system designers and architects
- logic and circuit designers
- validation engineers
- CAD managers
- researchers and academicians

Curvilinear Design and Application

Aki Fujimura, CEO

D2S

How to Improve Performance and Connect with EDA Software Using the Open-Access API

Yong-Hwan Jeon (Jason), CAD Engineer

SK-hynix

An AI-Powered IC Routing

Ed Grenert, Founder

Frontier Design Automation

Fast Connectivity Highlighting with Polygon Operators Extension

Simone Comensoli, Staff Software Systems Engineer

PDF Solutions

Heterogeneous 3D Design with OpenAccess

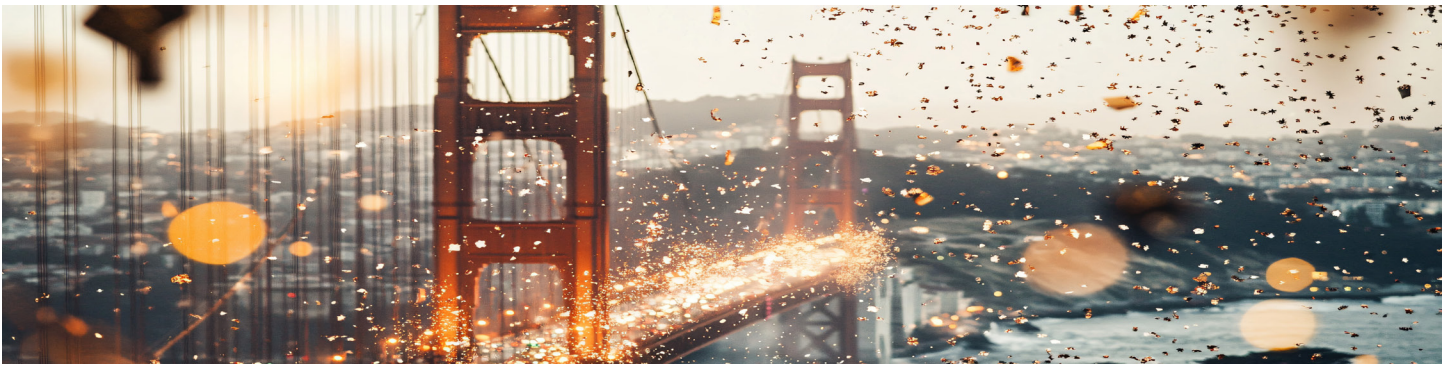
Rhett Davis, Professor

Electrical and Computer Engineering

NCSU

Advanced Registration is Required.
Click [Here](#) to Register





Join Us at the Si2 Annual Member Celebration at DAC 2025

For Si2 Members and their Guests

Tuesday, June 24, 4:00 - 6:00 PM

Moscone West | Room 3016

Join us for a celebration of collaboration at our annual members' meeting and reception. Gather with members, the board of directors, staff, and special guests as we toast to our joint achievements over the past year and see a sneak preview of our newest initiatives. Si2 will also present the annual Power of Partnerships Award.

The program will wrap up with a lively networking reception, where you can relax, connect, and share in the excitement with fellow DAC attendees.

Special Presentation by NVIDIA

Evaluation of LLMs for Si Design
Nathaniel Pinckney, Senior Research Scientist, NVIDIA

Hors D'oerves | Beer and Wine | Door Prizes
Admission is complimentary for Si2 members and their guests.

Advanced Registration is Required.
Click [Here](#) to Register



ICMC 2025

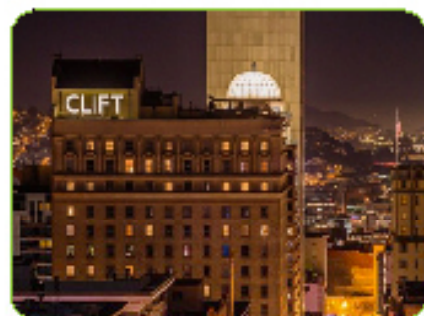
International Compact Modeling Conference

June 26-27, 2025 || The Clift Royal Sonesta, San Francisco

<https://2025.sl2-icmc.org/>

The Compact Model Coalition (CMC) brings academia and industry partners together in the development and standardization of compact models for semiconductor devices. For 30 years now, the CMC has been instrumental in creating standardized and verified models for designers to use in their increasingly complex circuits for SPICE simulation.

The CMC is organizing a new and innovative International Compact Modeling Conference. Cosponsored by IEEE EDS, it will focus uniquely on compact device models, their development and broad application in the semiconductor industry. You are invited to participate in the evolution of these models, guide model development to help circuit designers create the best circuit performance possible, and enable foundries to leverage the strength of their device fabrication to full extent. Join the world experts in design, process technology, and model development to discuss state of the art semiconductor device modeling for a two-day in-person event in one location, offering a great opportunity to present and learn about this core element of circuit design and how to get the most from these global collaborations.



THE CLIFT ROYAL SONESTA

Book by May 26, 2025, to receive the reduced rate.

Classic and contemporary with a nod to its storied past, The Clift Royal Sonesta San Francisco provides a wide array of amenities and services to make your stay comfortable.

495 Geary Street,
San Francisco, CA 94102

KEYNOTE SPEAKERS



Colin McAndrew

IEEE Life Fellow; NXP Fellow (retired);
ECpE; Iowa State University



Keith Green

Texas Instruments; Distinguished
Member of the Technical Staff



Sayeef Salahuddin

EECS, University of California, Berkeley;
TSMC Distinguished Professor and IEEE,
APS and AAAS Fellow

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